

# HAT2282C

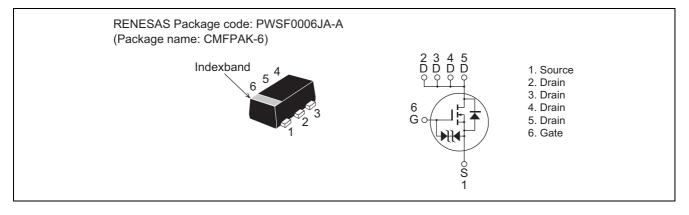
Silicon N Channel MOS FET Power Switching

> REJ03G1329-0100 Rev.1.00 Jan 26, 2006

### Features

- Low on-resistance  $R_{DS(on)} = 173 \text{ m}\Omega \text{ typ.}(at V_{GS} = 4.5 \text{ V})$
- Low drive current
- High density mounting
- 2.5 V gate drive device

### Outline



### **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to Source voltage	V <sub>DSS</sub>	60	V
Gate to Source voltage	V <sub>GSS</sub>	±12	V
Drain current	ID	1.5	А
Drain peak current	I <sub>D (pulse)</sub> Note1	6	А
Body - Drain diode reverse Drain current	I <sub>DR</sub>	1.5	А
Channel dissipation	Pch Note2	830	mW
Channel temperature	Tch	150	٥°
Storage temperature	Tstg	-55 to +150	٥°

Notes: 1.  $PW \le 10 \ \mu s$ , duty cycle  $\le 1\%$ 

2. When using the glass epoxy board (FR4  $40 \times 40 \times 1.6$ mm)



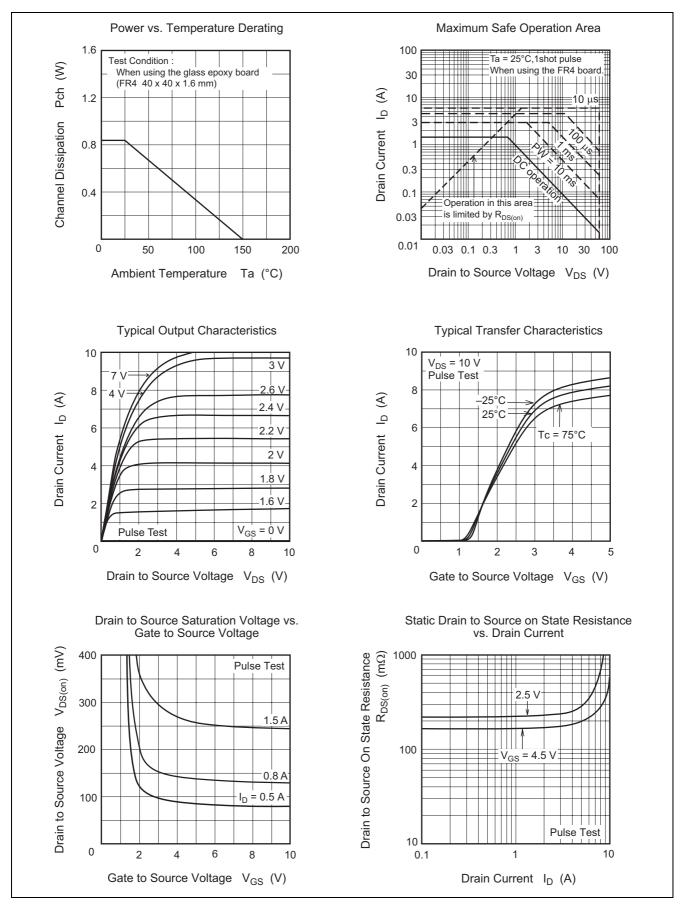
## **Electrical Characteristics**

Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Drain to Source breakdown voltage	V <sub>(BR)DSS</sub>	60	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$	
Gate to Source breakdown voltage	V <sub>(BR)GSS</sub>	±12				$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$	
Gate to Source leak current	I <sub>GSS</sub>			±10	μΑ	$V_{GS} = \pm 10 \text{ V}, V_{DS} = 0$	
Drain to Source leak current	I <sub>DSS</sub>			1	μΑ	$V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0$	
Gate to Source cutoff voltage	V <sub>GS(off)</sub>	0.4		1.4	V	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	
Drain to Source on state resistance	R <sub>DS(on)</sub>		173	225	mΩ	$I_D = 0.8 \text{ A}, V_{GS} = 4.5 \text{ V}^{\text{Note3}}$	
	R <sub>DS(on)</sub>	_	207	290	mΩ	$I_D = 0.8 \text{ A}, V_{GS} = 2.5 \text{ V}^{\text{Note3}}$	
Forward transfer admittance	y <sub>fs</sub>	2.3	3.5	_	S	$I_D = 0.8 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note3}}$	
Input capacitance	Ciss		200	_	pF	$V_{DS} = 10 V, V_{GS} = 0,$	
Output capacitance	Coss		25	_	pF	f = 1 MHz	
Reverse transfer capacitance	Crss	_	15	_	pF		
Turn - on delay time	t <sub>d(on)</sub>	_	10	_	ns	I <sub>D</sub> = 0.8 A	
Rise time	tr	_	26	_	ns	$V_{GS} = 4.5 \text{ V}, V_{DD} = 10 \text{ V}$	
Turn - off delay time	t <sub>d(off)</sub>		30	_	ns	$R_L$ = 1.25 Ω, Rg = 4.7 Ω	
Fall time	t <sub>f</sub>		4	_	ns		
Total Gate charge	Qg		2.4	_	nC	$V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}$	
Gate to Source charge	Qgs	_	0.4	_	nC	I <sub>D</sub> = 1.5 A	
Gate to Drain charge	Qgd	_	0.6	_	nC	1	
Body - Drain diode forward voltage	V <sub>DF</sub>		0.8	1.1	V	$I_F = 1.5 \text{ A}, V_{GS} = 0^{\text{Note3}}$	

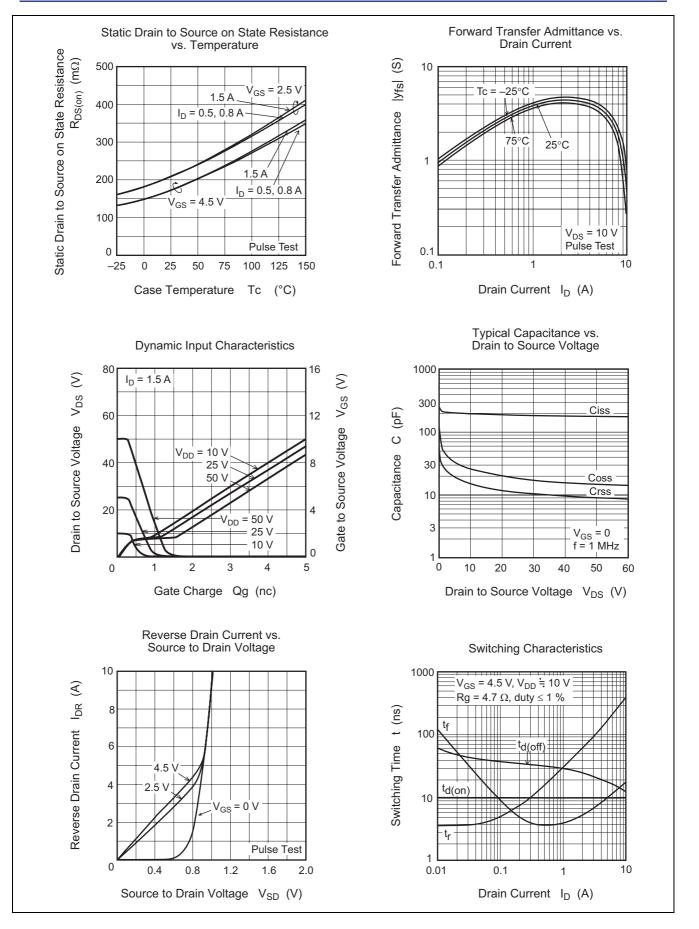
Notes: 3. Pulse test



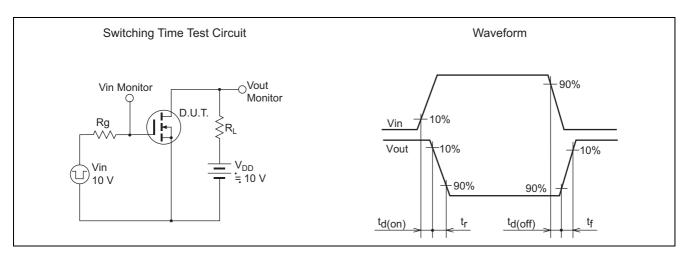
### **Main Characteristics**





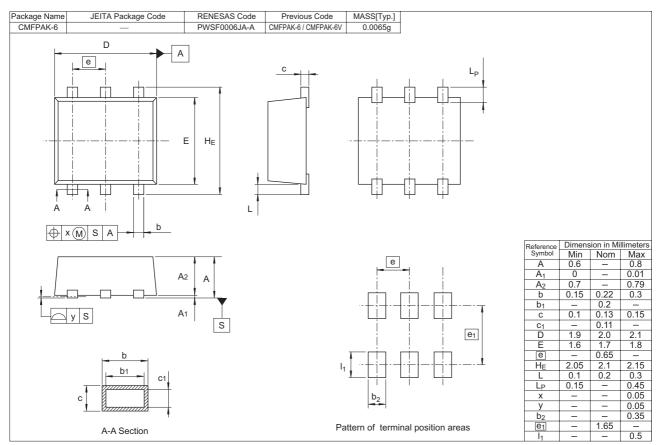








### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
HAT2282C-EL-E	3000 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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